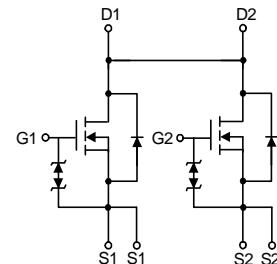
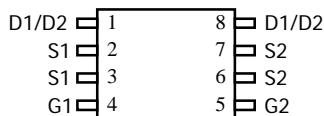


TM08EH02TS
N+N-Channel Enhancement Mode MOSFET

<p>General Description</p> <ul style="list-style-type: none"> • Low $R_{DS(on)}$ • RoHS and Halogen-Free Compliant <p>Applications</p> <ul style="list-style-type: none"> • Load switch • PWM 	<p>Product Summary</p> <p>$V_{DS} = 20V$ $I_D = 8.0A$</p> <p>$R_{DS(on)} = 13.5m\Omega$ (typ) @ $VGS=4.5V$</p> <p>ESD protection</p> <p>100% UIS Tested 100% R_g Tested</p> 
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TS:TSSOP-8L


Marking 8810 OR 08EH02

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise specified)

Symbol	Parameter	Max.	Units	
V_{DSS}	Drain-Source Voltage	20	V	
V_{GSS}	Gate-Source Voltage	± 12	V	
I_D	Continuous Drain Current	$T_A = 25^\circ C$	8.0	A
		$T_A = 100^\circ C$	4.5	A
I_{DM}	Pulsed Drain Current ^{note1}	27	A	
P_D	Power Dissipation	$T_A = 25^\circ C$	0.83	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	151	$^\circ C/W$	
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	$^\circ C$	

TM08EH02TS
N+N-Channel Enhancement Mode MOSFET
Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	20	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=20\text{V}$, $V_{GS}=0\text{V}$,	-	-	1	μA
I_{GSS}	Gate to Body Leakage Current	$V_{DS}=0\text{V}$, $V_{GS}= \pm 10\text{V}$	-	-	± 10	uA
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	0.4	0.7	1	V
$R_{DS(\text{on})}$ note2	Static Drain-Source on-Resistance	$V_{GS}=4.5\text{V}$, $I_D=4\text{A}$	-	13.5	16	$\text{m}\Omega$
		$V_{GS}=2.5\text{V}$, $I_D=3\text{A}$	-	17	24	
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=10\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$	-	645	-	pF
C_{oss}	Output Capacitance		-	103	-	pF
C_{rss}	Reverse Transfer Capacitance		-	90	-	pF
Q_g	Total Gate Charge	$V_{DS}=10\text{V}$, $I_D=4.8\text{A}$, $V_{GS}=4.5\text{V}$	-	8	-	nC
Q_{gs}	Gate-Source Charge		-	2.5	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	3	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=10\text{V}$, $R_L=1.5\Omega$, $R_{GEN}=3\Omega$, $V_{GS}=5\text{V}$	-	0.5	-	ns
t_r	Turn-on Rise Time		-	1	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	12	-	ns
t_f	Turn-off Fall Time		-	4	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current	-	-	8.0	A	
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current	-	-	19	A	
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}$, $I_S=4.8\text{A}$	-	-	1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

TM08EH02TS

N+N-Channel Enhancement Mode MOSFET

Typical Performance Characteristics

Figure 1: Output Characteristics

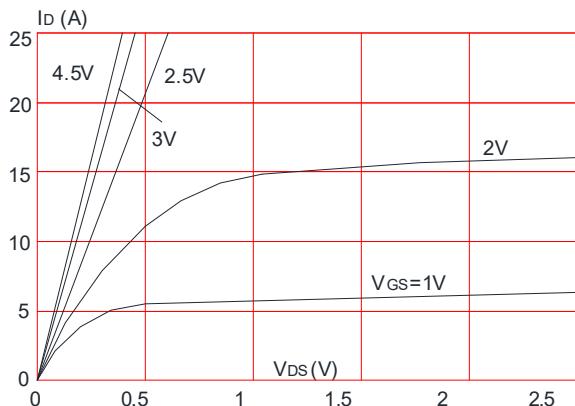


Figure 3: On-resistance vs. Drain Current

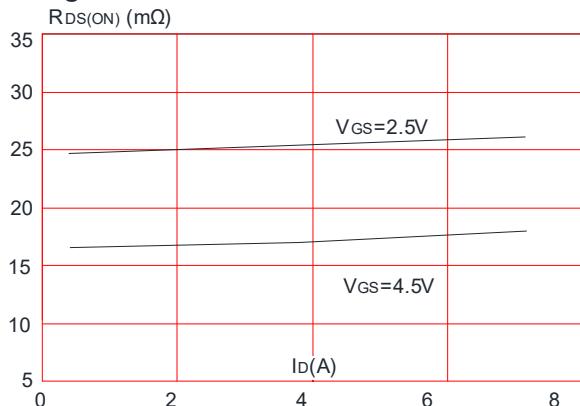


Figure 5: Gate Charge Characteristics

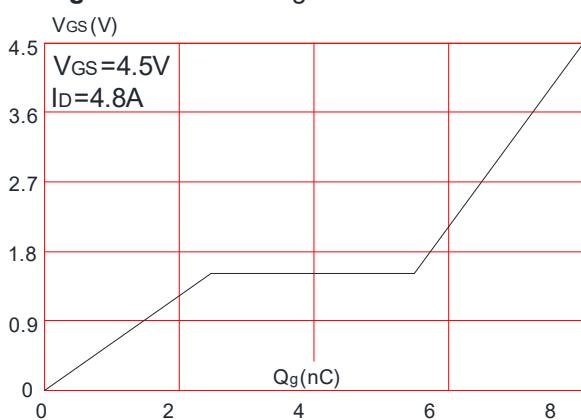


Figure 2: Typical Transfer Characteristics

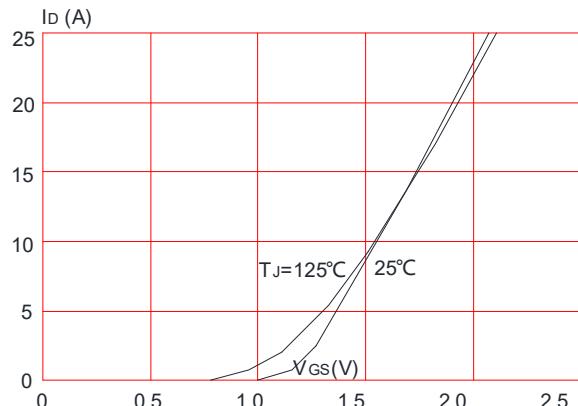


Figure 4: Body Diode Characteristics

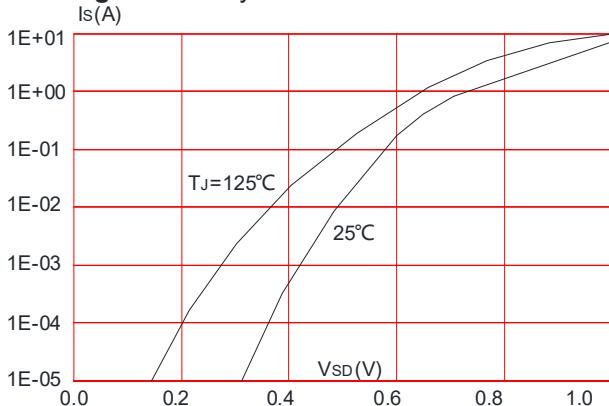
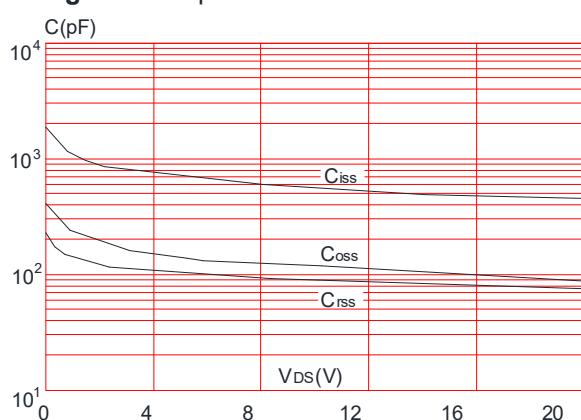


Figure 6: Capacitance Characteristics



TM08EH02TS

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Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

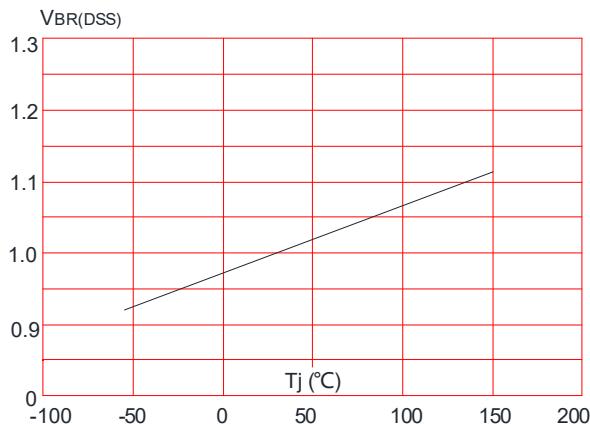


Figure 8: Normalized on Resistance vs. Junction Temperature

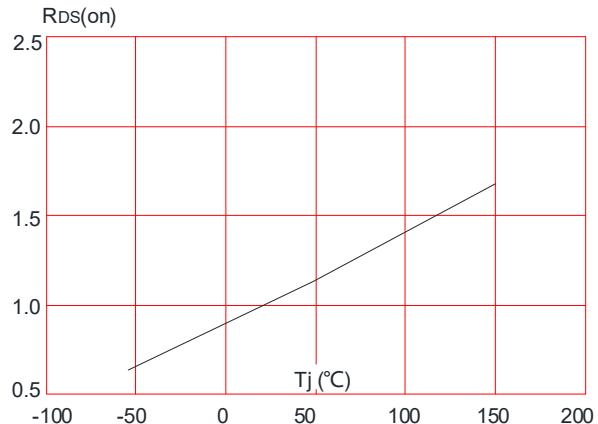


Figure 9: Maximum Safe Operating Area

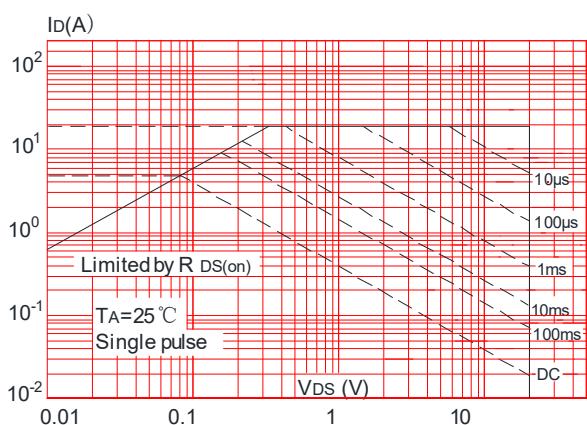


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature

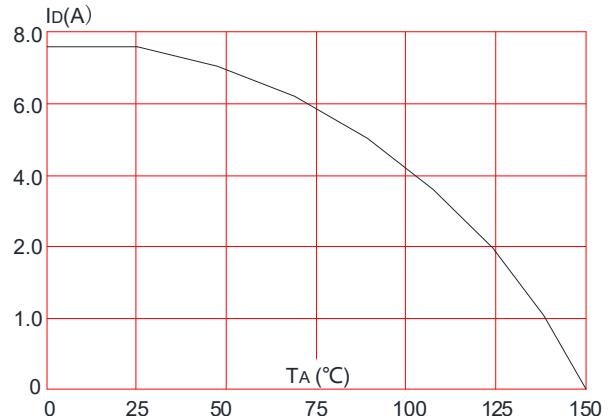
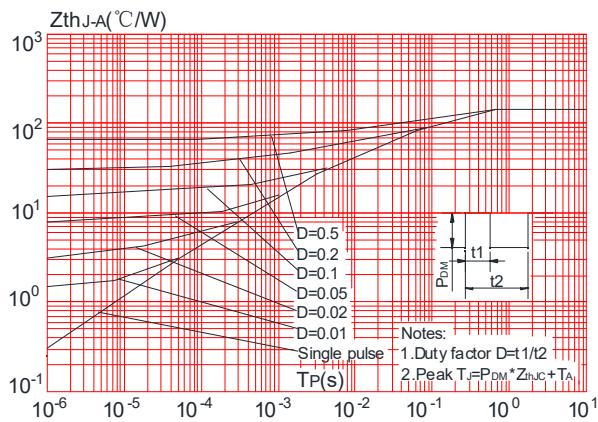


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



Test Circuit

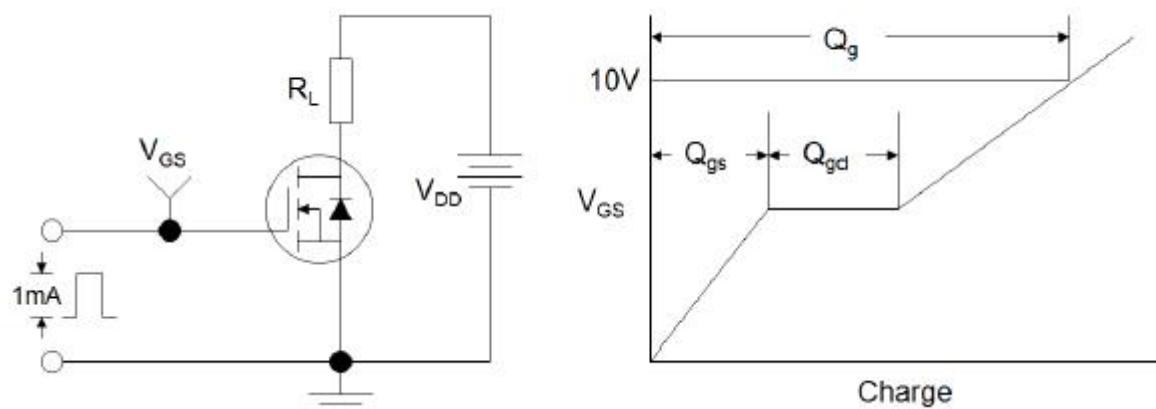


Figure1:Gate Charge Test Circuit & Waveform

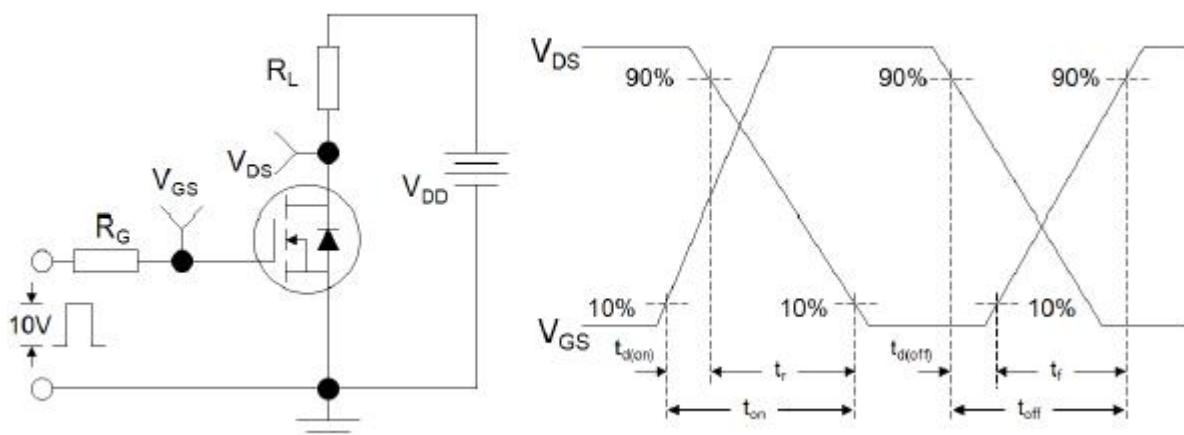


Figure 2: Resistive Switching Test Circuit & Waveforms

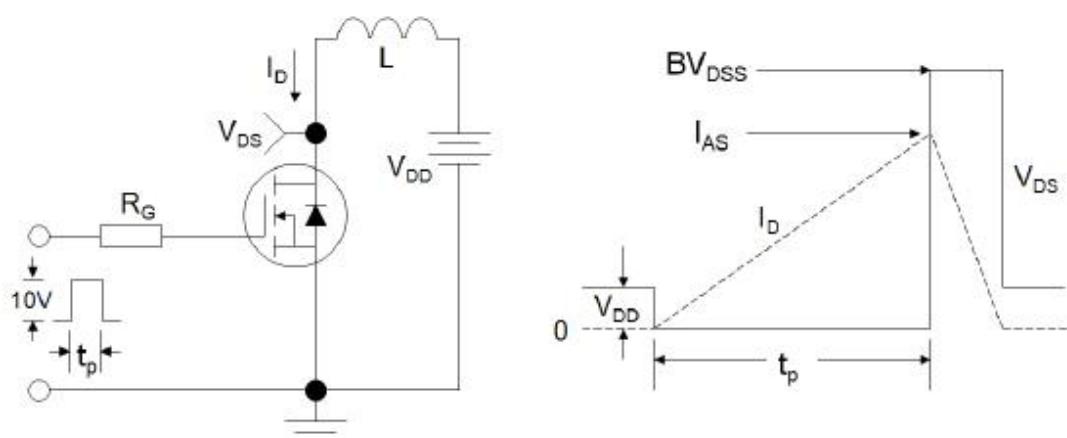
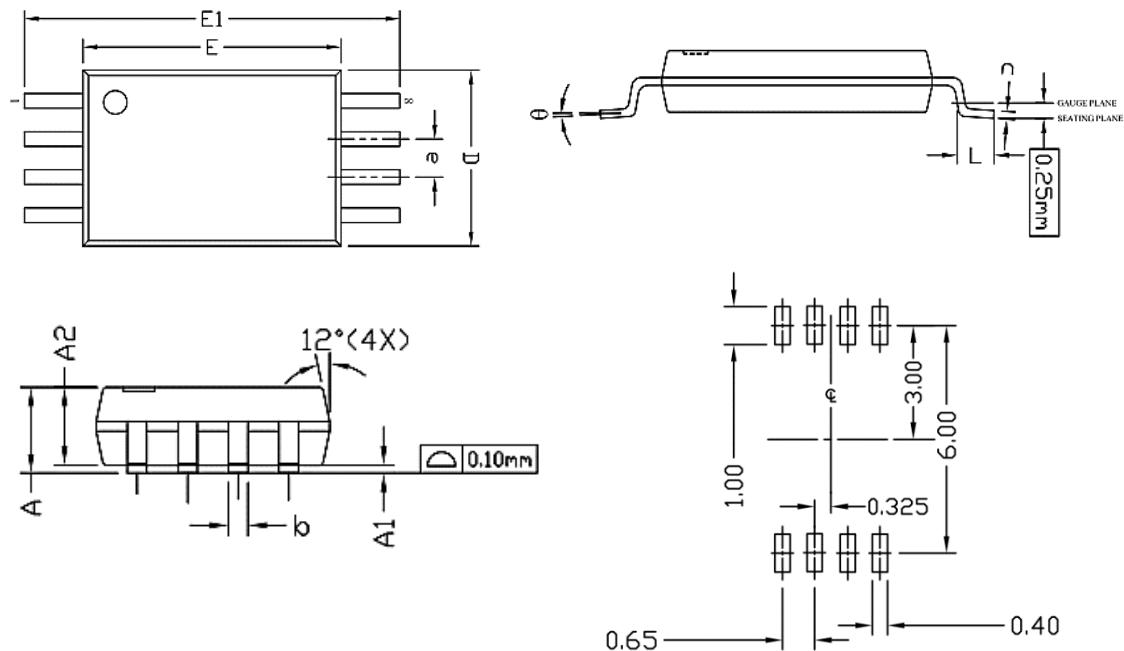


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

Package Mechanical Data: TSSOP-8L



Symbol	Common		
	mm		
	Mim	Nom	Max
A	/	/	1.20
A1	0.05	/	0.15
A2	0.80	1.00	1.05
b	0.19	/	0.30
c	0.09	/	3.45
D	2.90	3.00	3.1
E1	6.40BSC		
E	4.30	4.40	4.50
E	0.65BSC		
L	0.45	0.60	0.75
Φ	0°	0.48	8°